

COMLINEAR[®] CLC1002 Ultra-Low Noise Amplifier

FEATURES

- 0.6 nV/ \sqrt{Hz} input voltage noise
- 1mV maximum input offset voltage
- 965MHz gain bandwidth product
- Minimum stable gain of 5
- 170V/µs slew rate
- 130mA output current
- -40°C to +125°C operating temperature range
- Fully specified at 5V and ±5V supple
- CLC1002: Lead-free SOT23-6

APPLICATIONS

- Transimpedance amplifiers
- Pre-amplifier
- Low noise signal processing
- Medical instrumentation
- Probe equipment
- Test equipment
- Ultrasound channel amplifier

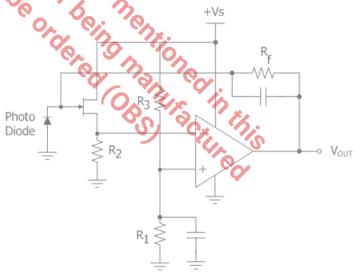
General Description

The COMLINEAR CLC1002(single) is a high-performance, voltage feedback amplifier with ultra-low input voltage noise, $0.6nV/\sqrt{Hz}$. The CLC1002 provides 965MHz gain bandwidth product and 170V/µs slew rate making it well suited for high-speed data acquisition systems requiring high levels of sensitivity and signal integrity. This COMLINEAR high-performance amplifier also offers low input offset voltage.

The COMLINEAR CLC1002 is designed to operate from 4V to 12V supplies. It consumes only 13mA of supply current per channel and offers a power saving disable pin that disables the amplifier and decreases the supply current to below 225 μ A. The CLC1002 amplifier operates over the extended temperature range of -40°C to +125°C.

If larger bandwidth or slew rate is required, a higher minimum stable gain version is available, the CLC1001 offers a minimum stable gain of 10 with 2.1GHz GBWP and 410V/ μ s slew rate.

Typical Application - Single Supply Photodiode Amplifier

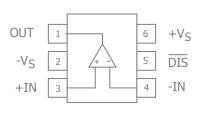


Ordering Information

Part Number	Package	Pb-Free	RoHS Compliant	Operating Temperature Range	Packaging Method
CLC1002IST6X	SOT23-6	Yes	Yes	-40°C to +125°C	Reel
CLC1002ISO8X	SOIC-8	Yes	Yes	-40°C to +125°C	Reel
CLC1002ISO8	SOIC-8	Yes	Yes	-40°C to +125°C	Rail

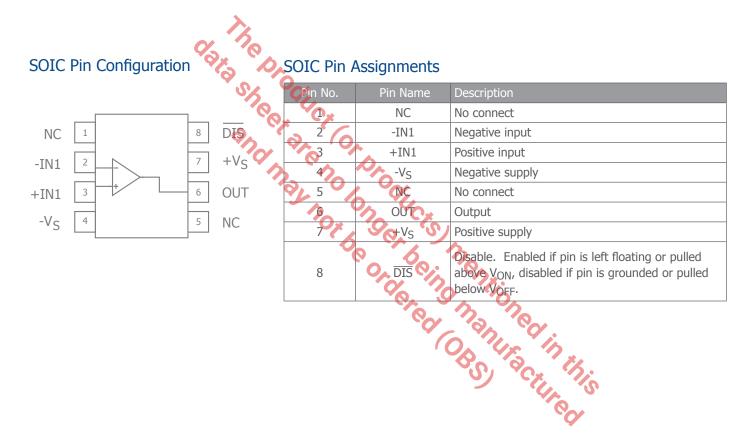
Moisture sensitivity level for all parts is MSL-1.

CLC1002 Pin Configuration



CLC1002 Pin Assignments

Pin No.	Pin Name	Description
1	OUT	Output
2	-V _S	Negative supply
3	+IN	Positive input
4	-IN	Negative input
5	DIS	Disable. Enabled if pin is left floating or pulled above V_{ON} , disabled if pin is grounded or pulled below V_{OFF} .
6	+V _S	Positive supply



Absolute Maximum Ratings

The safety of the device is not guaranteed when it is operated above the "Absolute Maximum Ratings". The device should not be operated at these "absolute" limits. Adhere to the "Recommended Operating Conditions" for proper device function. The information contained in the Electrical Characteristics tables and Typical Performance plots reflect the operating conditions noted on the tables and plots.

Parameter	Min	Max	Unit
Supply Voltage	0	14	V
Input Voltage Range	-V _s -0.5V	+V _s +0.5V	V

Reliability Information

Parameter	Min	Тур	Max	Unit
Junction Temperature			150	°C
Storage Temperature Range	-65		150	°C
Lead Temperature (Soldering, 105)			260	°C
Package Thermal Resistance				
6-Lead SOT23		177		°C/W
8-Lead SOIC		100		°C/W
Notes:				

Package thermal resistance (θ_{1A}), JDEC standard, multi-layer test boards, still ai

ESD Protection

Product	SOT23-6
Human Body Model (HBM)	2 2 2 1 2 1 2 1 2 1 2 1 2 1 2 1 2 1 2 1
Charged Device Model (CDM)	2k7

Recommended Operating Conditions

Recommended Operating Conditions	Ord Cl	nonti-	
Parameter	Min	Max	Unit
Operating Temperature Range (CLC1002I)	-40 💙	A A B 5	°C
Operating Temperature Range (CLC1002A)	-40	+125	°C
Supply Voltage Range	4		V
			0

Electrical Characteristics at +5V

 T_A = 25°C, V_s = +5V, -V_s = GND, R_f = 100 Ω , R_L = 500 Ω to $V_S/2,$ G = 5; unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Frequency D	omain Response					
GBWP	-3dB Gain Bandwidth Product	$G = +21, V_{OUT} = 0.2V_{pp}$		910		MHz
BW _{SS}	-3dB Bandwidth	$G = +5, V_{OUT} = 0.2V_{pp}$		265		MHz
BW _{LS}	Large Signal Bandwidth	$G = +5$, $V_{OUT} = 2V_{pp}$		54		MHz
BW _{0.1dBSS}	0.1dB Gain Flatness Small Signal	$G = +5$, $V_{OUT} = 0.2V_{pp}$		37		MHz
BW _{0.1dBLS}	0.1dB Gain Flatness Large Signal	$G = +5$, $V_{OUT} = 2V_{pp}$		29		MHz
Time Domair	Response					
t _R , t _F	Rise and Fall Time	V _{OUT} = 1V step; (10% to 90%)		4.2		ns
t _S	Settling Time to 0.1%	V _{OUT} = 1V step		12		ns
OS	Overshoot 🔪	V _{OUT} = 1V step		3		%
SR	Slew Rate	4V step		160		V/µs
Distortion/No	pise Response					
HD2	2nd Harmonic Distortion	1V _{pp} , 10MHz		-72		dBc
HD3	3rd Harmonic Distortion	1V _{pp} , 10MHz		-74		dBc
THD	Total Harmonic Distortion	Vpp, 10MHz		-70		dB
e _n	Input Voltage Noise	> 100kHz		0.6		nV/√Hz
i _n	Input Current Noise	> 100ktz		4.2		pA/√Hz
DC Performa	nce	R D.	<u> </u>			
V _{IO}	Input Offset Voltage	no for the second secon		0.1		mV
dV _{IO}	Average Drift			2.7		µV/°C
Ib	Input Bias Current			28		μΑ
dIb	Average Drift			46		nA/°C
Io	Input Offset Current	0 1 h		0.1		μA
PSRR	Power Supply Rejection Ratio	DC O O		83		dB
A _{OL}	Open-Loop Gain	$V_{OUT} = V_S / 2$		80		dB
I _S	Supply Current	per channel		12.5		mA
Disable Char	acteristics	0 12 10				1
t _{on}	Turn On Time	1V step, 1% settling		80		ns
t _{OFF}	Turn Off Time		7 ,	220		ns
OFFISO	Off Isolation	2V _{pp} , 5MHz	Cx S	73		dB
OFFC _{OUT}	Off Output Capacitance	bb.	4	S _{5.8}		pF
V _{OFF}	Power Down Voltage	Disabled if DIS pin is grounded or pulled below V _{OFF}	Disa	bled if DIS <	1.5	V
V _{ON}	Enable Voltage	Enabled if $\overline{\text{DIS}}$ pin is floating or pulled above V_{ON}		abled if DIS >		V
I _{SD}	Disable Supply Current	No Load, DIS pin tied to ground		130	5	μA
Input Charac	,	, . ,				r
R _{IN}	Input Resistance	Non-inverting		4.2		MΩ
C _{IN}	Input Capacitance			2		pF
	Common Mode Input Range			0.8 to		V
CMIR				5.1		
CMRR	Common Mode Rejection Ratio	DC , V _{cm} =1.5V to 4V		94		dB
Output Chara				0.071		
		$R_L = 500\Omega$		0.97 to 4		V
V _{OUT}	Output Voltage Swing	P - 21/0		0.96 to		
		$R_L = 2k\Omega$		4.1		V
I _{OUT}	Output Current			±125		mA
I _{SC}	Short-Circuit Output Current	$V_{OUT} = V_S / 2$		±150		mA

Notes:

1. 100% tested at 25°C

Electrical Characteristics at ±5V

 T_A = 25°C, V_s = ±5V, R_f = 100 $\Omega,\,R_L$ = 500 Ω , G = 5; unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Frequency De	omain Response					
GBWP	-3dB Gain Bandwidth Product	$G = +21, V_{OUT} = 0.2V_{pp}$		965		MHz
BW _{SS}	-3dB Bandwidth	$G = +5, V_{OUT} = 0.2V_{pp}$		290		MHz
BW _{LS}	Large Signal Bandwidth	$G = +5$, $V_{OUT} = 2V_{pp}$		61		MHz
BW _{0.1dBSS}	0.1dB Gain Flatness Small Signal	$G = +5, V_{OUT} = 0.2V_{pp}$		45		MHz
BW _{0.1dBLS}	0.1dB Gain Flatness Large Signal	$G = +5$, $V_{OUT} = 2V_{pp}$		32		MHz
Time Domair	Response	· · · · · · · · · · · · · · · · · · ·				
t _R , t _F	Rise and Fall Time	V _{OUT} = 1V step; (10% to 90%)		3.8		ns
t _s	Settling Time to 0.1%	V _{OUT} = 1V step		12		ns
OS	Overshoot 🔪	V _{OUT} = 1V step		2		%
SR	Slew Rate	2V step		170		V/µs
Distortion/No	vise Response	· · · ·				
HD2	2nd Harmonic Distortion	2V _{pp} , 10MHz		-75		dBc
HD3	3rd Harmonic Distortion	2V _{pp} , 10MHz		-66		dBc
THD	Total Harmonic Distortion	2Vpp, 5MHz		-65.5		dB
e _n	Input Voltage Noise	> 100kHz		0.6		nV/√Hz
i _n	Input Current Noise	> 100kHz		4.2		pA/√Hz
DC Performa	nce	Q D				
V _{IO}	Input Offset Voltage ⁽¹⁾		-1	0.5	1	mV
dV _{IO}	Average Drift	1. 6. 4		4.3		μV/°C
I _b	Input Bias Current (1)	Pour la Cz	-60	30	60	μA
dI _b	Average Drift			44		nA/°C
I _o	Input Offset Current	0 / h		0.3	6	μA
PSRR	Power Supply Rejection Ratio (1)	DC O O	78	83		dB
A _{OL}	Open-Loop Gain (1)	$V_{OUT} = V_S / 2$	70	83		dB
I _S	Supply Current ⁽¹⁾	per channel		13	16	mA
Disable Chara	acteristics	60 B. (6				
t _{on}	Turn On Time	1V step, 1% settling	1	115		ns
t _{OFF}	Turn Off Time		· 7 ,	210		ns
OFFISO	Off Isolation	2V _{pp} , 5MHz	Cx.	73		dB
OFFC _{OUT}	Off Output Capacitance		4	5.7		pF
V _{OFF}	Power Down Voltage	Disabled if $\overline{\text{DIS}}$ pin is grounded or pulled below V _{OFF}	Dis	bled if DIS	< 1.3	V
V _{ON}	Enable Voltage	Enabled if DIS pin is floating or pulled above V_{ON}		abled if DIS		V
I _{SD}	Disable Supply Current (1)	No Load, DIS pin tied to ground		180	225	μA
Input Charac	teristics			1 1		1
R _{IN}	Input Resistance	Non-inverting		9.4		MΩ
C _{IN}	Input Capacitance			1.82		pF
CMIR	Common Mode Input Range			-4.3 to 5		V
CMRR	Common Mode Rejection Ratio ⁽¹⁾	DC , V _{cm} =-3.5V to 4V	75	90		dB
Output Chara						
		$R_{\rm I} = 500\Omega^{(1)}$	-3.3	±4	3.6	V
V _{OUT}	Output Voltage Swing	$R_L = 2k\Omega$		±4		V
I _{OUT}	Output Current			±130		mA
I _{SC}	Short-Circuit Output Current	$V_{OUT} = V_S / 2$		±165		mA

Notes:

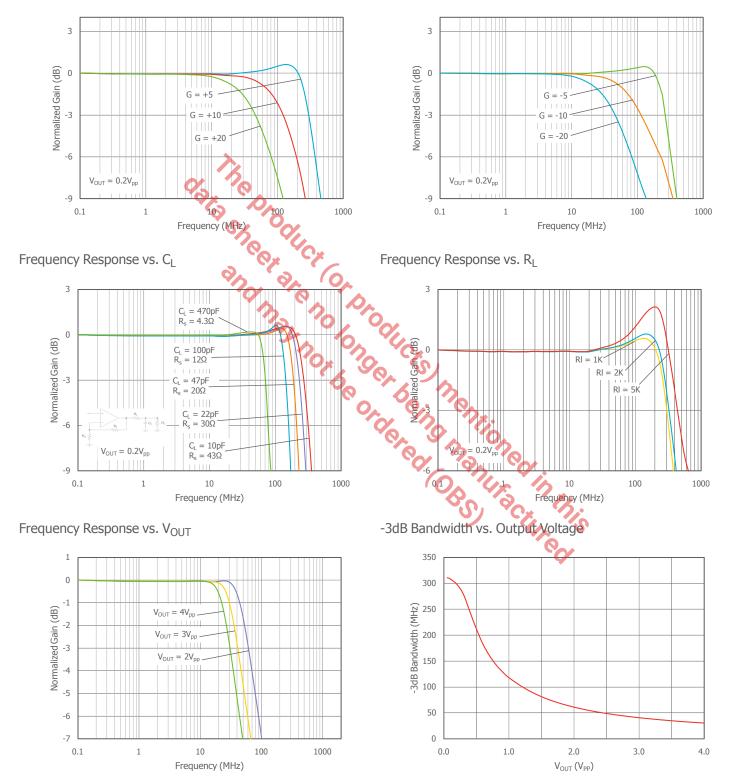
1. 100% tested at 25°C

Typical Performance Characteristics

 $T_A=25^{o}C,\,V_S=\pm5V,\,R_f=100\Omega,\,R_L=500\Omega$, G=5; unless otherwise noted.

Non-Inverting Frequency Response

Inverting Frequency Response

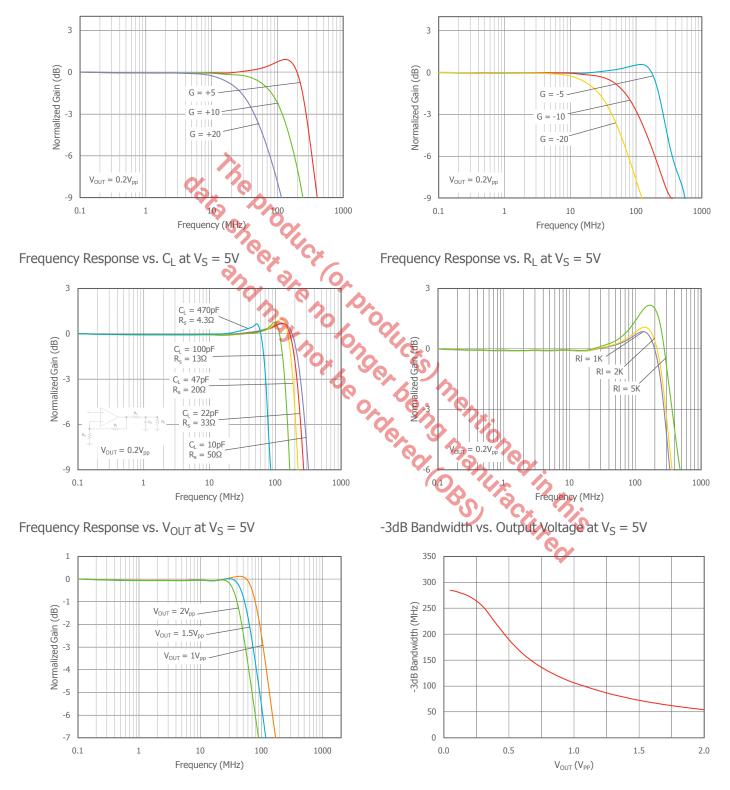


Typical Performance Characteristics

 T_A = 25°C, V_s = ±5V, R_f = 100 $\Omega,\,R_L$ = 500 Ω , G = 5; unless otherwise noted.

Non-Inverting Frequency Response at $V_S = 5V$

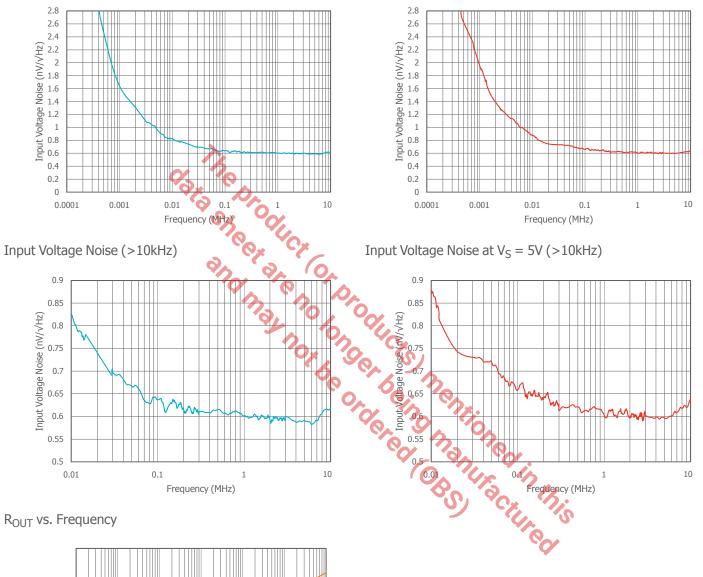
Inverting Frequency Response at $V_S = 5V$

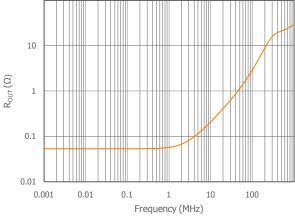


 T_A = 25°C, V_s = ±5V, R_f = 100 $\Omega,$ R_L = 500 Ω , G = 5; unless otherwise noted.

Input Voltage Noise

Input Voltage Noise at $V_S = 5V$

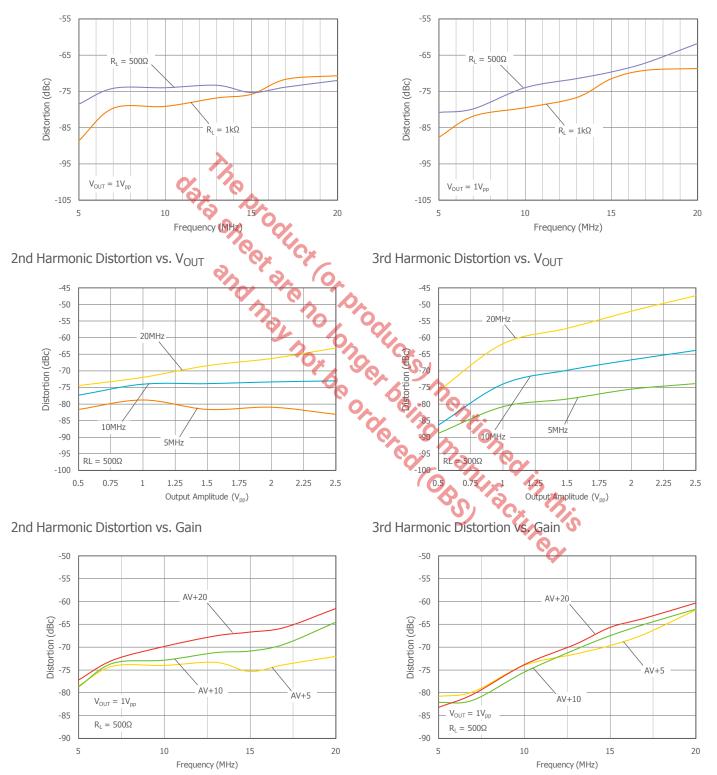




 $T_A=25^{\circ}C,\,V_s=\pm5V,\,R_f=100\Omega,\,R_L=500\Omega$, G=5; unless otherwise noted.

2nd Harmonic Distortion vs. R_L

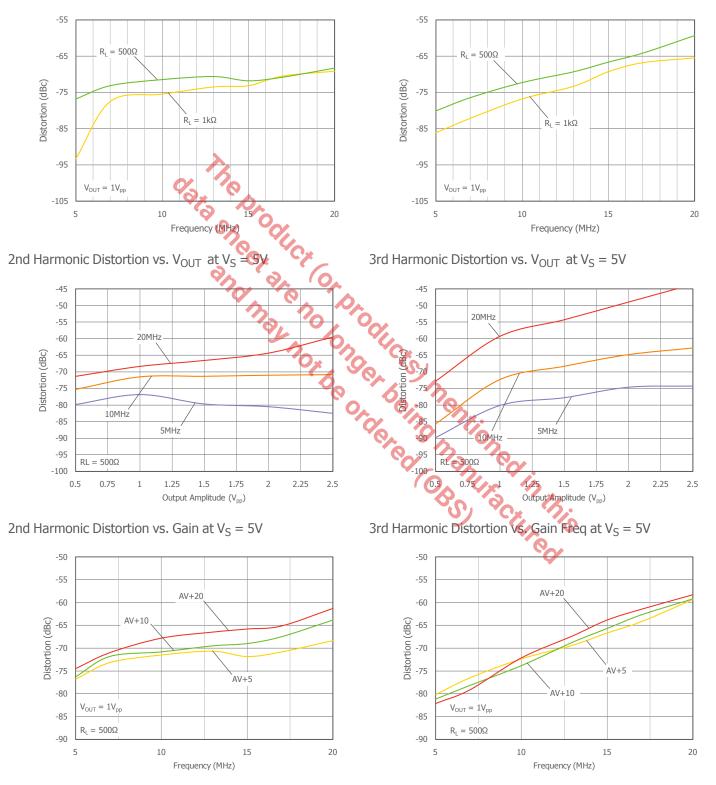
3rd Harmonic Distortion vs. R_L



 T_A = 25°C, V_s = ±5V, R_f = 100 $\Omega,$ R_L = 500 Ω , G = 5; unless otherwise noted.

2nd Harmonic Distortion vs. R_L at V_S = 5V

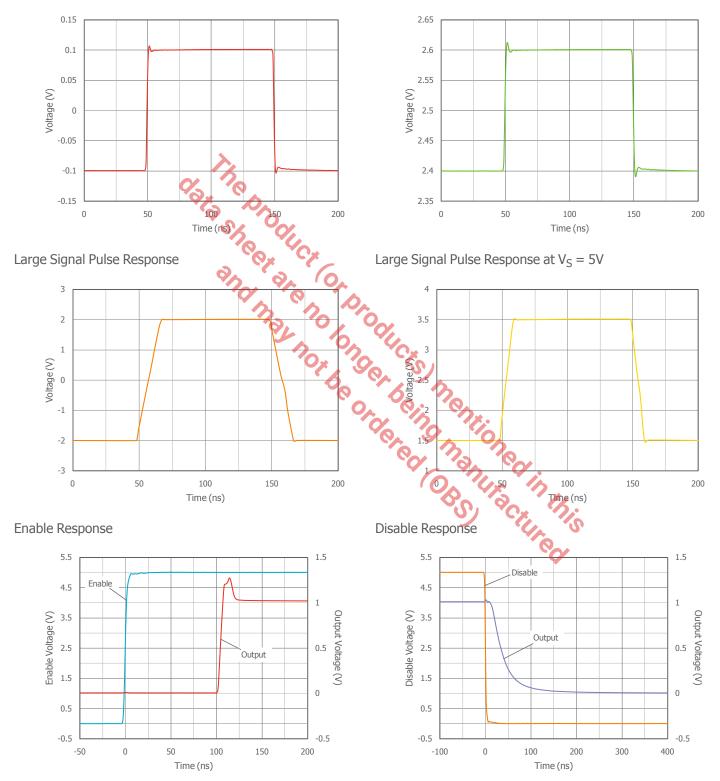




 $T_A=25^{\circ}C,\,V_s=\pm5V,\,R_f=100\Omega,\,R_L=500\Omega$, G=5; unless otherwise noted.

Small Signal Pulse Response

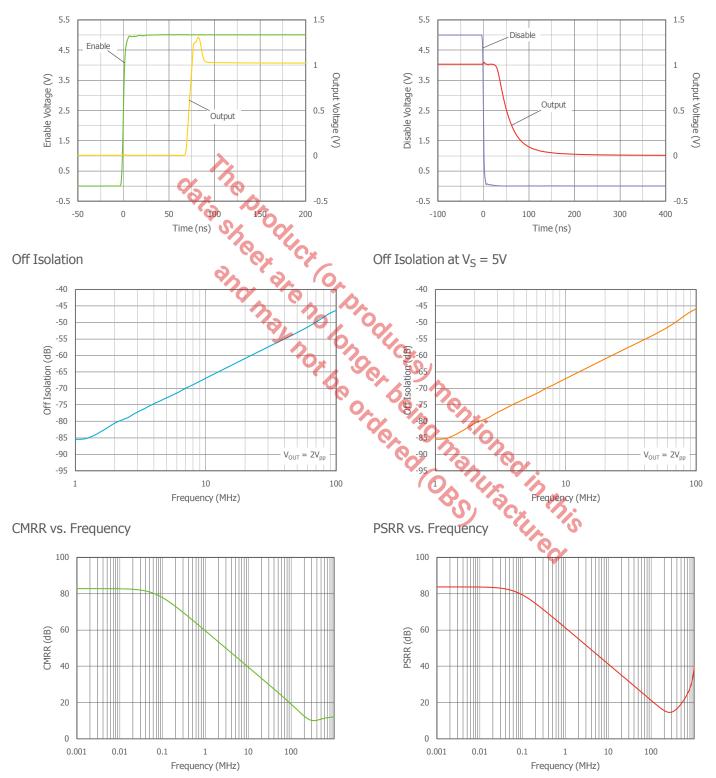
Small Signal Pulse Response at $V_S = 5V$



 $T_A=25^{\circ}C,\,V_s=\pm5V,\,R_f=100\Omega,\,R_L=500\Omega$, G=5; unless otherwise noted.

Enable Response at $V_S = 5V$

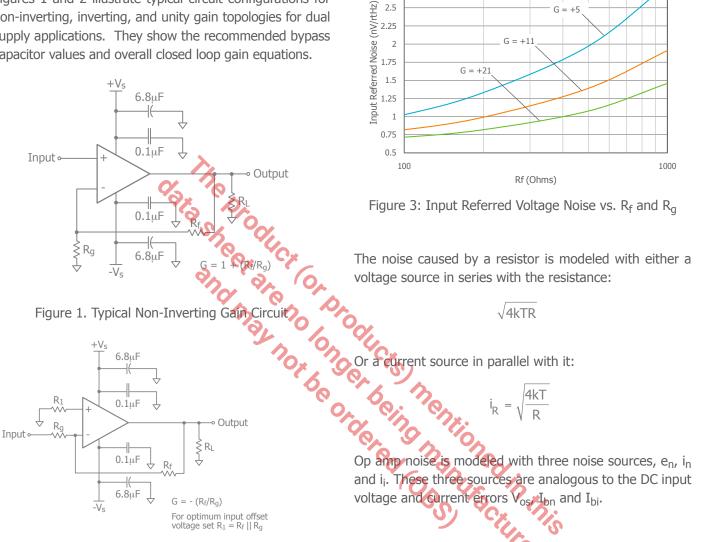
Disable Response at $V_S = 5V$



Application Information

Basic Operation

Figures 1 and 2 illustrate typical circuit configurations for non-inverting, inverting, and unity gain topologies for dual supply applications. They show the recommended bypass capacitor values and overall closed loop gain equations.



input referred noise also increases.

G = +5

G = +11

3 2.75

Figure 2. Typical Inverting Gain Circuit

Achieving Low Noise in an Application

Making full use of the low noise of the CLC1002 requires careful consideration of resistor values. The feedback and gain set resistors (R_f and R_q) and the non-inverting source impedance (R_{source}) all contribute noise to the circuit and can easily dominate the overall noise if their values are too high. The datasheet is specified with an R_q of 25 Ω , at which point the noise from R_f and R_q is about equal to the noise from the CLC1002. Lower value resistors could be used at the expense of more distortion.

Figure 3 shows total input voltage noise (amp+resistors) versus R_f and R_a. As the value of R_f increases, the total The noise models must be analyzed in-circuit to determine the effect on the op amp output noise.

Since noise is statistical in nature rather than a continuous signal, the set of noise sources in circuit add in an RMS (root mean square) fashion rather than in a linear fashion. For uncorrelated noise sources, this means you add the squares of the noise voltages. A typical non-inverting application (see figure 1) results in the following noise at the output of the op amp:

$$e_{o}^{2} = e_{n}^{2} \left(1 + \frac{R_{f}}{R_{g}}\right)^{2} + in^{2}R_{s}^{2} \left(1 + \frac{R_{f}}{R_{g}}\right)^{2} + i_{i}^{2}R_{f}^{2}$$

op amp noise terms e_n, i_n and i_i

+
$$e_{Rs}^2 \left(1 + \frac{R_f}{R_g}\right)^2$$
 + $e_{Rg}^2 \left(\frac{R_f}{R_g}\right)^2$ + e_{Rf}^2

external resistor noise terms for R_S, R_a and R_f

High source impedances are sometimes unavoidable, but they increase noise from the source impedance and also make the circuit more sensitive to the op amp current noise. Analyze all noise sources in the circuit, not just the op amp itself, to achieve low noise hyour application.

Power Dissipation Power dissipation should not be a factor when operating under the stated 500Ω load condition. However, applications with low impedance, DC coupled loads should be analyzed to ensure that maximum allowed junction temperature is not exceeded. Guidelines listed below can be used to verify that the particular application will not cause the device to operate beyond it's intended operating range.

Maximum power levels are set by the absolute maximum junction rating of 150°C. To calculate the junction temperature, the package thermal resistance value Theta_{1A} (Θ_{1A}) is used along with the total die power dissipation.

$$T_{Junction} = T_{Ambient} + (\Theta_{JA} \times P_D)$$

Where T_{Ambient} is the temperature of the working environment.

In order to determine P_D, the power dissipated in the load needs to be subtracted from the total power delivered by the supplies.

$$P_D = P_{supply} - P_{load}$$

Supply power is calculated by the standard power equation.

$$\label{eq:Psupply} \begin{split} \mathsf{P}_{supply} &= \mathsf{V}_{supply} \times \, \mathrm{I}_{RMS \; supply} \\ \mathsf{V}_{supply} &= \mathsf{V}_{S+} - \mathsf{V}_{S-} \end{split}$$

Power delivered to a purely resistive load is:

$$P_{load} = ((V_{LOAD})_{RMS^2})/Rload_{eff}$$

The effective load resistor (Rloadeff) will need to include the effect of the feedback network. For instance, Rloadeff ©2007-2013 Exar Corporation

in figure 3 would be calculated as:

$$R_{L} || (R_{f} + R_{g})$$

These measurements are basic and are relatively easy to perform with standard lab equipment. For design purposes however, prior knowledge of actual signal levels and load impedance is needed to determine the dissipated power. Here, P_D can be found from

$$P_D = P_{Quiescent} + P_{Dynamic} - P_{Load}$$

Quiescent power can be derived from the specified IS values along with known supply voltage, V_{Supply}. Load power can be calculated as above with the desired signal amplitudes using:

$$(V_{LOAD})_{RMS} = V_{PEAK} / \sqrt{2}$$

$$(I_{LOAD})_{RMS} = (V_{LOAD})_{RMS} / Rload_{eff}$$

The dynamic power is focused primarily within the output stage driving the load. This value can be calculated as:

$$P_{\text{DYNAMIC}} = (V_{\text{S+}} - V_{\text{LOAD}})_{\text{RMS}} \times (I_{\text{LOAD}})_{\text{RMS}}$$

Assuming the load is referenced in the middle of the power rails or $V_{supply}/2$.

Figure 4 shows the maximum safe power dissipation in the package vs? the ambient temperature for the packages available

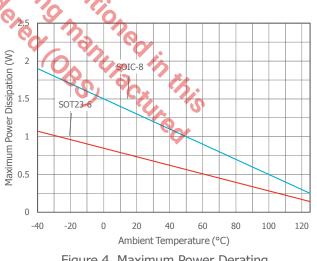


Figure 4. Maximum Power Derating

Driving Capacitive Loads

Increased phase delay at the output due to capacitive loading can cause ringing, peaking in the frequency response, and possible unstable behavior. Use a series resistance, R_S, between the amplifier and the load to help improve stability and settling performance. Refer to Figure 5.

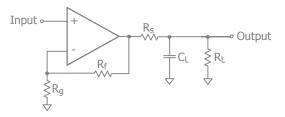


Figure 5. Addition of R_S for Driving Capacitive Loads

Table 1 provides the recommended R_S for various capacitive loads. The recommended R_S values result in <=1dB peaking in the frequency response. The Frequency Response vs. C_L plots, on page 7, illustrates the response of the CLC1002.

C _L (pF)	R _S (Ω)	3dB BW (MHz)	
10	43	\$ 275	
22	30	235	
47	20	190	2
100	12	146	
470	4.3	72	

Table 1: Recommended R_S vs. C_L

For a given load capacitance, adjust R_S to optimize the tradeoff between settling time and bandwidth. In general reducing R_S will increase bandwidth at the expense of additional overshoot and ringing.

Overdrive Recovery

An overdrive condition is defined as the point when either one of the inputs or the output exceed their specified voltage range. Overdrive recovery is the time needed for the amplifier to return to its normal or linear operating point. The recovery time varies, based on whether the input or output is overdriven and by how much the range is exceeded. The CLC1002 will typically recover in less than 25ns from an overdrive condition. Figure 6 shows the CLC1002 in an overdriven condition.

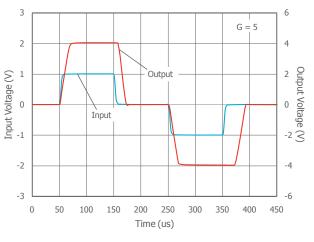


Figure 6. Overdrive Recovery

Layout Considerations

General layout and supply bypassing play major roles in high frequency performance. Exar has evaluation boards to use as a guide for high frequency layout and as aid in device testing and characterization. Follow the steps below as basis for high frequency layout:

- Include 6.8µF and 0.1µF ceramic capacitors for power supply decoupling
- Place the 6.8 pF capacitor within 0.75 inches of the power pin
- Place the 0.1μ F capacitor within 0.1 inches of the power pin
- Remove the ground plane under and around the part, especially near the input and output pins to reduce parasitic capacitance
- Minimize all trace lengths to reduce series inductances

Refer to the evaluation board layouts below for more information.

Evaluation Board Information

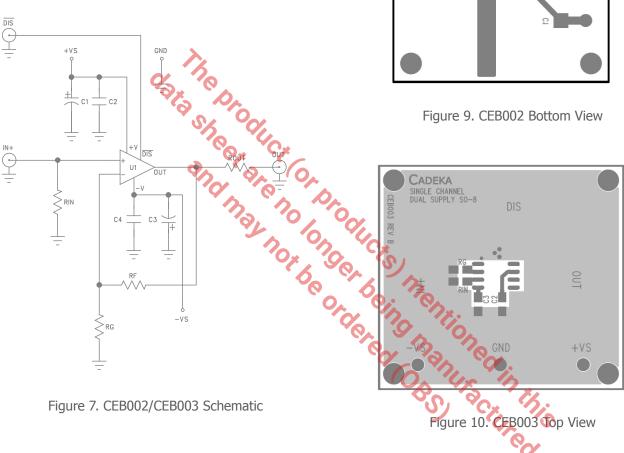
The following evaluation boards are available to aid in the testing and layout of these devices:

Evaluation Board	Products
CEB002	CLC1002 in SOT23-5
CEB003	CLC1002 in SOIC-8

Evaluation Board Schematics

Evaluation board schematics and layouts are shown in Figures 7-11. These evaluation boards are built for dual- supply operation. Follow these steps to use the board in a single-supply application:

- 1. Short -Vs to ground.
- 2. Use C3 and C4, if the $\mbox{-}V_{S}$ pin of the amplifier is not directly connected to the ground plane.



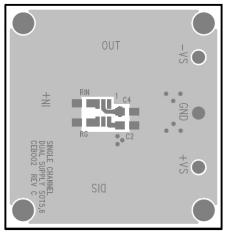


Figure 8. CEB002 Top View

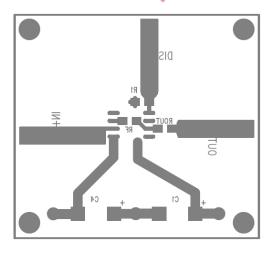
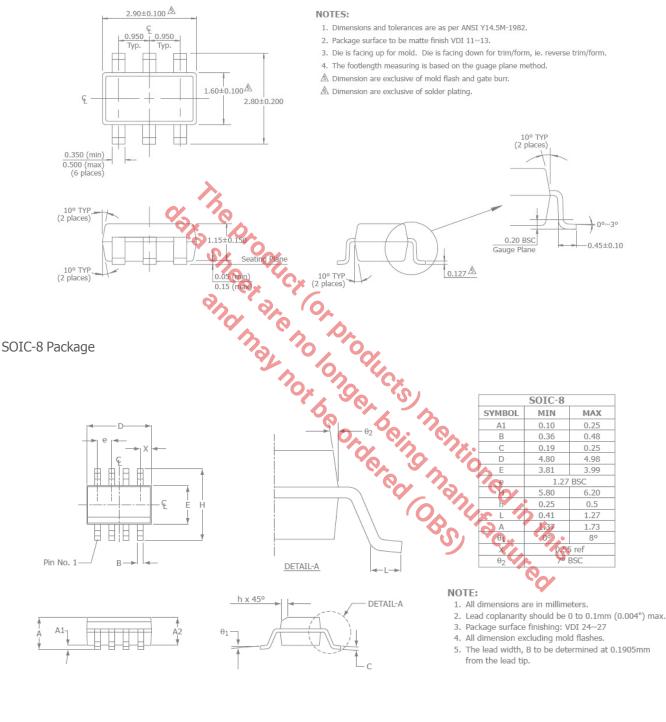


Figure 11. CEB003 Bottom View

Mechanical Dimensions

SOT23-6 Package



For Further Assistance:

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